

Data Sheet

**High thermal conductivity Low transmission loss
Halogen-free Multi-layer circuit board materials**

Material for PA and Antenna application

XPEDION T1

**Laminate R-5575
Prepreg R-5470**

July 2022 No.22072950

Specification / Laminate R-5575

Property		Units	Test Method	Condition	Typical Value	
THERMAL	Glass Transition Temp (Tg)		C	TMA	As received	205
				DMA	As received	245
	Thermal Decomposition Temp (Td)		C	TGA	As received	440
	Time to Delam (T288)	Without Cu	min	IPC TM-650 2.4.24.1	As received	> 120
		With Cu	min	IPC TM-650 2.4.24.1	As received	> 120
	CTE : $\alpha 1$	X - axis	ppm / C	IPC TM-650 2.4.24	< Tg	13 - 16
		Y - axis	ppm / C	IPC TM-650 2.4.24	< Tg	13 - 16
		Z - axis	ppm / C	IPC TM-650 2.4.24	< Tg	20
	CTE : $\alpha 2$	Z - axis	ppm / C	IPC TM-650 2.4.24	> Tg	155
Thermal Conductivity		W / m K	Laser flash	25C	0.60	
ELECTRICAL	Volume Resistivity		M Ω - cm	IPC TM-650 2.5.17.1	C-96/35/90	1 x 10 ⁹
	Surface Resistivity		M Ω	IPC TM-650 2.5.17.1	C-96/35/90	1 x 10 ⁸
	Dielectric Constant (Dk)	@ 1GHz	-	IPC TM-650 2.5.5.9	C-24/23/50	3.73
		@ 13GHz	-	" Note 1	C-24/23/50	3.60
	Dissipation Factor (Df)	@ 1GHz	-	IPC TM-650 2.5.5.9	C-24/23/50	0.002
		@ 13GHz	-	" Note 1	C-24/23/50	0.0045
PHYSICAL	Water Absorption		%	IPC TM-650 2.6.2.1	D-24/23	0.23
	Peel Strength	1oz (RTF)	kN / m	IPC TM-650 2.4.8	As received	0.8
	Flammability		-	UL	C-48/23/50	94V-0

Sample thickness : 30 mil = 0.76 mm (Core Type 30) #1078 x 9ply

Note 1 : Balanced-type Circular Disk Resonance Method [IEC 63185 (2020)]

* The data in the above table are not guaranteed values.

Specification / Laminate R-5575

1GHz ; IPC TM650-2.5.5.9

13-55GHz ; Balanced-type Circular Disk Resonance Method [IEC 63185 (2020)]

Core Type	Actual Thickness		Cloth Style	ply	Typical Resin Content (%)	Typical Dk					
	mil	mm				1GHz	13GHz	23GHz	34GHz	45GHz	55GHz
4	4.0	0.102	1078	1	75	3.60	3.49	3.49	3.49	3.49	3.49
5	5.0	0.127	3313	1	66	3.80	3.66	3.66	3.66	3.66	3.66
5	5.0	0.127	1078	1	79	3.53	3.42	3.42	3.42	3.42	3.42
6	6.0	0.152	2116	1	63	3.87	3.72	3.72	3.72	3.72	3.72
6.6	6.6	0.168	1078	2	69	3.73	3.60	3.60	3.60	3.60	3.60
6.6	6.6	0.168	1067	2	80	3.51	3.40	3.40	3.40	3.40	3.40
8	8.0	0.203	1078	2	75	3.60	3.49	3.49	3.49	3.49	3.49
10	10.0	0.254	1078	3	69	3.73	3.60	3.60	3.60	3.60	3.60
10	10.0	0.254	3313	2	66	3.80	3.66	3.66	3.66	3.66	3.66
13.3	13.3	0.338	1078	4	69	3.73	3.60	3.60	3.60	3.60	3.60
13.3	13.3	0.338	1067	4	80	3.51	3.40	3.40	3.40	3.40	3.40
16.6	16.6	0.422	1078	5	69	3.73	3.60	3.60	3.60	3.60	3.60
16.6	16.6	0.422	1067	5	80	3.51	3.40	3.40	3.40	3.40	3.40
20	20.0	0.508	1078	6	69	3.73	3.60	3.60	3.60	3.60	3.60
20	20.0	0.508	3313	4	66	3.80	3.66	3.66	3.66	3.66	3.66
30	30.0	0.762	1078	9	69	3.73	3.60	3.60	3.60	3.60	3.60
30	30.0	0.762	3313	6	66	3.80	3.66	3.66	3.66	3.66	3.66

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Specification / Laminate R-5575

1GHz ; IPC TM650-2.5.5.9

13-55GHz ; Balanced-type Circular Disk Resonance Method [IEC 63185 (2020)]

Core Type	Actual Thickness		Cloth Style	ply	Typical Resin Content (%)	Typical Df					
	mil	mm				1GHz	13GHz	23GHz	34GHz	45GHz	55GHz
4	4.0	0.102	1078	1	75	0.002	0.0044	0.0046	0.005	0.0053	0.0056
5	5.0	0.127	3313	1	66	0.002	0.0045	0.0048	0.0052	0.0056	0.0059
5	5.0	0.127	1078	1	79	0.002	0.0043	0.0046	0.0049	0.0052	0.0055
6	6.0	0.152	2116	1	63	0.002	0.0046	0.0049	0.0053	0.0057	0.006
6.6	6.6	0.168	1078	2	69	0.002	0.0045	0.0048	0.0051	0.0055	0.0058
6.6	6.6	0.168	1067	2	80	0.002	0.0043	0.0046	0.0049	0.0052	0.0055
8	8.0	0.203	1078	2	75	0.002	0.0044	0.0046	0.005	0.0053	0.0056
10	10.0	0.254	1078	3	69	0.002	0.0045	0.0048	0.0051	0.0055	0.0058
10	10.0	0.254	3313	2	66	0.002	0.0045	0.0048	0.0052	0.0056	0.0059
13.3	13.3	0.338	1078	4	69	0.002	0.0045	0.0048	0.0051	0.0055	0.0058
13.3	13.3	0.338	1067	4	80	0.002	0.0043	0.0046	0.0049	0.0052	0.0055
16.6	16.6	0.422	1078	5	69	0.002	0.0045	0.0048	0.0051	0.0055	0.0058
16.6	16.6	0.422	1067	5	80	0.002	0.0043	0.0046	0.0049	0.0052	0.0055
20	20.0	0.508	1078	6	69	0.002	0.0045	0.0048	0.0051	0.0055	0.0058
20	20.0	0.508	3313	4	66	0.002	0.0045	0.0048	0.0052	0.0056	0.0059
30	30.0	0.762	1078	9	69	0.002	0.0045	0.0048	0.0051	0.0055	0.0058
30	30.0	0.762	3313	6	66	0.002	0.0045	0.0048	0.0052	0.0056	0.0059

* The data in the above table are not guaranteed values.

Specification / Prepreg R-5470

1GHz ; IPC TM650-2.5.5.9

13-55GHz ; Balanced-type Circular Disk Resonance Method [IEC 63185 (2020)]

Cloth Style	Resin Content (%)	Typical Thickness (um)	Typical Dk					
			1GHz	13GHz	23GHz	34GHz	45GHz	55GHz
1067	78	75	3.54	3.44	3.44	3.44	3.44	3.44
	81	90	3.49	3.38	3.38	3.38	3.38	3.38
	83	100	3.45	3.35	3.35	3.35	3.35	3.35
1078	79	125	3.53	3.42	3.42	3.42	3.42	3.42

Cloth Style	Resin Content (%)	Typical Thickness (um)	Typical Df					
			1GHz	13GHz	23GHz	34GHz	45GHz	55GHz
1067	78	75	0.002	0.0043	0.0046	0.0049	0.0052	0.0055
	81	90	0.002	0.0043	0.0046	0.0049	0.0052	0.0055
	83	100	0.002	0.0042	0.0045	0.0047	0.0050	0.0052
1078	79	125	0.002	0.0043	0.0046	0.0049	0.0052	0.0055

* The data in the above table are not guaranteed values.

++ Before purchase ++

【Notes before you use】

- Please verify the suitability and fitness for intended application by quality testing, evaluation or other means at your own option before any adoption, use or change of use conditions of a product listed in the datasheet.
- We would like to have a delivery specifications mutually agreed for the product that you have decided to use. The agreements defined in the delivery specifications are assigned higher priority.
- Please note that images shown may somewhat differ from the actual product in color.
- Please note that specifications and external design are subject to change for product improvement without notice.
- For details on products in the datasheet, please contact your distributor or our sales department.

【Safety Information】

- Before using the product, please read the delivery specifications carefully or contact the distributor from which you purchased the product or our sales department in order to use the product correctly.
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Panasonic Industry Co., Ltd.
 Electronic Materials Business Division
 Circuit Board Materials Business Unit.
 Head Office: 1006 Kadoma, Kadoma City, Osaka 571-8506
 TEL: 81-6-6908-1101
industrial.panasonic.com/ww/electronic-materials